# MOSFET – Power, Single **N-Channel** 40 V, 3.3 mΩ, 102 A

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS5C450NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



# **ON Semiconductor®**

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V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
40 V	$3.3~\mathrm{m}\Omega$ @ 10 V	102 A

D (5,6)

(T <sub>J</sub> = 25°0	C unless otherv	vise noted)		
Parameter			Value	Unit
Drain-to-Source Voltage			40	V
Gate-to-Source Voltage			±20	V
	$T_{C} = 25^{\circ}C$	I <sub>D</sub>	102	А
Steady State	T <sub>C</sub> = 100°C		72	1
	T <sub>C</sub> = 25°C	PD	68	W
	T <sub>C</sub> = 100°C		34	1
Steady	$T_A = 25^{\circ}C$	۱ <sub>D</sub>	24	А
	T <sub>A</sub> = 100°C		17	
State	$T_A = 25^{\circ}C$	PD	3.6	W
	$T_A = 100^{\circ}C$		1.8	1
T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	554	А
Operating Junction and Storage Temperature			–55 to + 175	°C
Source Current (Body Diode)			65	А
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 7.0 A)			215	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			260	°C
	neter Pe Steady State Steady State $T_A = 25$ Storage T Diode) Source Av oldering P	neter Pe T <sub>C</sub> = 25°C T <sub>C</sub> = 100°C T <sub>A</sub> = 25°C T <sub>A</sub> = 100°C T <sub>A</sub> = 100°C T <sub>A</sub> = 25°C T <sub>A</sub> = 100°C	e $V_{DSS}$ e $V_{GS}$ steady $T_C = 25^{\circ}C$ $I_D$ $T_C = 100^{\circ}C$ $T_C = 100^{\circ}C$ $T_C = 100^{\circ}C$ $T_C = 100^{\circ}C$ $T_C = 100^{\circ}C$ $T_A = 25^{\circ}C$ $I_D$ $T_A = 25^{\circ}C$ $I_D$ $T_A = 25^{\circ}C$ $P_D$ $T_A = 100^{\circ}C$ $T_A = 100^{$	Symbol         Value           Ie $V_{DSS}$ 40           Ie $V_{GS}$ $\pm 20$ Steady $T_C = 25^{\circ}C$ $I_D$ 102 $T_C = 100^{\circ}C$ $T_C = 25^{\circ}C$ $P_D$ 68 $T_C = 100^{\circ}C$ $T_C = 100^{\circ}C$ 34 $T_C = 100^{\circ}C$ $T_C = 100^{\circ}C$ 17 $Steady$ $T_A = 25^{\circ}C$ $P_D$ 68 $T_C = 100^{\circ}C$ $I_D$ 24 $Steady$ $T_A = 25^{\circ}C$ $P_D$ 3.6 $T_A = 100^{\circ}C$ $T_A = 100^{\circ}C$ 1.8 $T_A = 25^{\circ}C$ , $t_p = 10  \mu s$ $I_{DM}$ 554           Storage Temperature $T_J$ , $T_{stg}$ -55 to + 175           biode)         I_S         65           Source Avalanche $E_{AS}$ 215           oldering Purposes $T_L$ 260

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

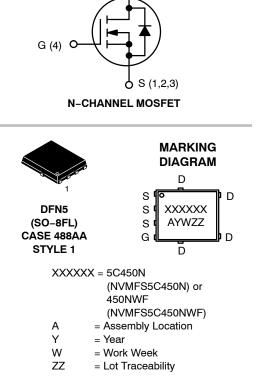
#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.2	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	41	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

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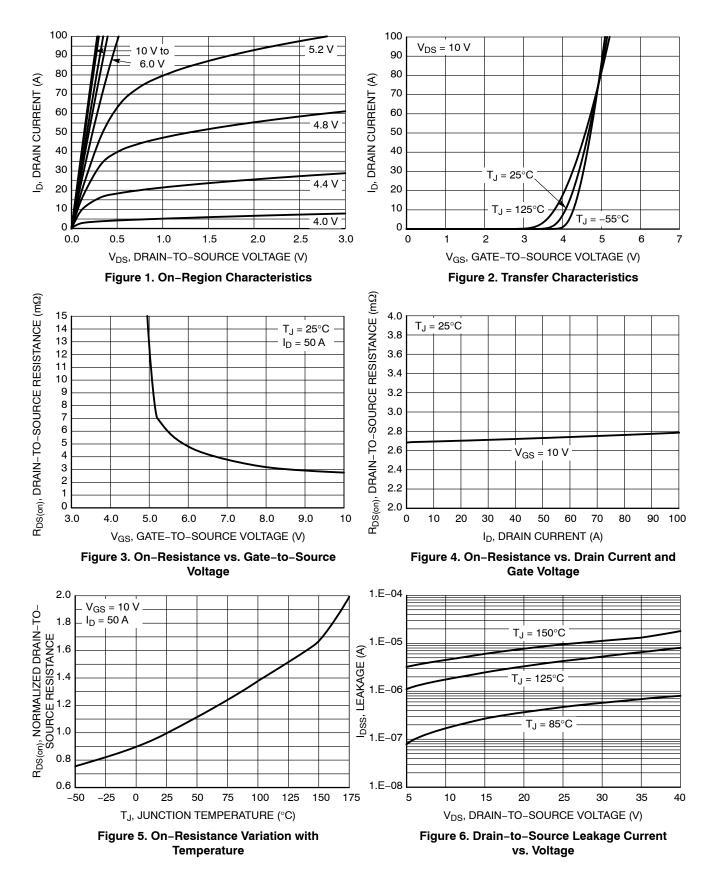
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS	<u> </u>							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 µA		40			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				20		mV/°C	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$ \begin{array}{c} V_{GS} = 0 \ V, \\ V_{DS} = 40 \ V \end{array} \qquad \begin{array}{c} T_{J} = 25^{\circ}C \\ T_{J} = 125^{\circ}C \end{array} $				10		
						100	μΑ	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{G}$	<sub>S</sub> = 20 V			100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>E</sub>	<sub>)</sub> = 65 μA	2.5		3.5	V	
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-9.1		mV/°C	
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 50 A		2.7	3.3	mΩ	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> =15 V, I	<sub>D</sub> = 50 A		93		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE					-	-	
Input Capacitance	C <sub>ISS</sub>	$V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}, V_{DS} = 25 \text{ V}$ $V_{GS} = 10 \text{ V}, V_{DS} = 20 \text{ V}; \text{ I}_{D} = 50 \text{ A}$			1600		pF	
Output Capacitance	C <sub>OSS</sub>				830			
Reverse Transfer Capacitance	C <sub>RSS</sub>				28			
Total Gate Charge	Q <sub>G(TOT)</sub>				23			
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 20 V; I <sub>D</sub> = 50 A			5.1		nC	
Gate-to-Source Charge	Q <sub>GS</sub>				9.0			
Gate-to-Drain Charge	Q <sub>GD</sub>				3.5			
Plateau Voltage	V <sub>GP</sub>				5.3		V	
SWITCHING CHARACTERISTICS (Note 5	5)							
Turn–On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 20 V, I <sub>D</sub> = 50 A, R <sub>G</sub> = 2.5 Ω			10		ns	
Rise Time	tr				47			
Turn–Off Delay Time	t <sub>d(OFF)</sub>				19			
Fall Time	t <sub>f</sub>				3.0			
DRAIN-SOURCE DIODE CHARACTERIS	TICS			-	•	•	•	
Forward Diode Voltage V <sub>SD</sub>	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.9	1.2		
		T <sub>J</sub> = 125°C		0.78		V		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dIS/dt = 100 A/µs, I <sub>S</sub> = 50 A			37		ns	
Charge Time	t <sub>a</sub>				18			
Discharge Time	t <sub>b</sub>				19			
Reverse Recovery Charge	Q <sub>RR</sub>				23		nC	

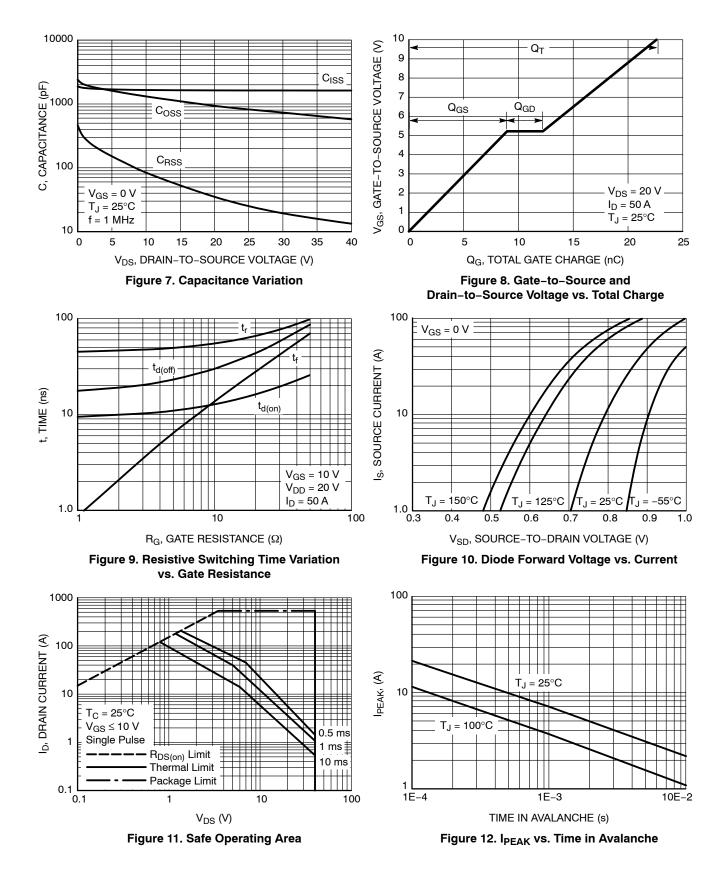
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ .

5. Switching characteristics are independent of operating junction temperatures.

### **TYPICAL CHARACTERISTICS**



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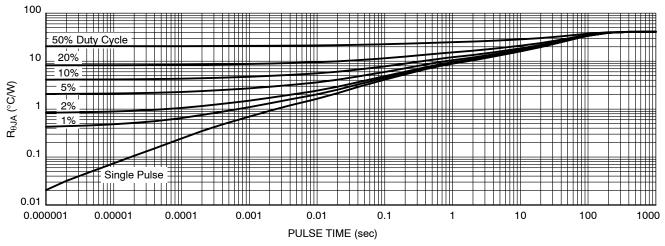
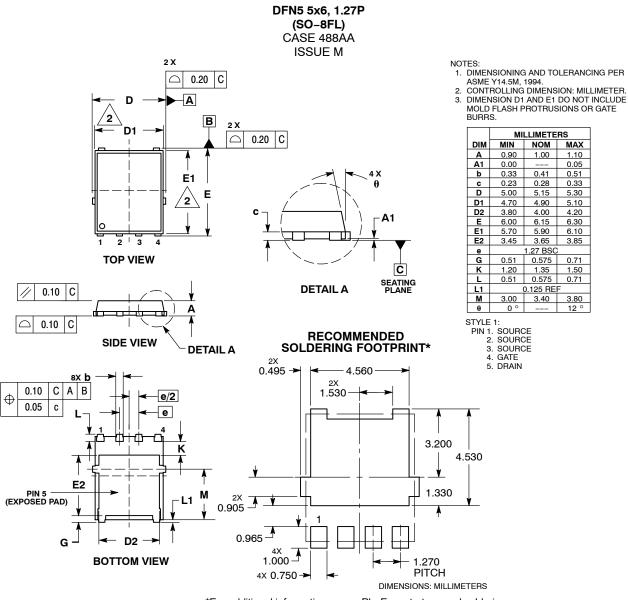


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION					
Device	Marking	Package	Shipping <sup>†</sup>		
NVMFS5C450NT1G	5C450N	DFN5 (Pb-Free)	1500 / Tape & Reel		
NVMFS5C450NWFT1G	450NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel		
NVMFS5C450NT3G	5C450N	DFN5 (Pb-Free)	5000 / Tape & Reel		
NVMFS5C450NWFT3G	450NWF	DFN5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel		
NVMFS5C450NAFT1G	5C450N	DFN5 (Pb-Free)	1500 / Tape & Reel		
NVMFS5C450NWFAFT1G	450NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### PUBLICATION ORDERING INFORMATION

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